



# High Speed Infrared Emitting Diode in T-1¾ Package

#### **Description**

TSHF5210 is a high speed infrared emitting diode in GaAlAs double hetero (DH) technology, molded in a clear, untinted plastic package.

TSHF5210 combines high speed with high radiant power at wavelength of 890 nm.

#### **Features**

- High modulation bandwidth
- Extra high radiant power and radiant intensity
- · Low forward voltage
- Suitable for high pulse current operation
- Standard package T-1¾ (Ø 5 mm)
- Angle of half intensity  $\varphi = \pm 10^{\circ}$
- Peak wavelength  $\lambda_p = 890 \text{ nm}$
- High reliability
- · Good spectral matching to Si photodetectors
- Lead (Pb)-free component
- Component in accordance with RoHS 2002/95/EC and WEEE 2002/96/EC



# **Applications**

Infrared high speed remote control and free air data transmission systems with high modulation frequencies or high data transmission rate requirements.

TSHF5210 is ideal for the design of transmission systems according to IrDA requirements and for carrier frequency based systems (e.g. ASK / FSK - coded, 450 kHz or 1.3 MHz).

#### **Parts Table**

Part	Remarks		
TSHF5210	MOQ: 4000 pcs		

#### **Absolute Maximum Ratings**

T<sub>amb</sub> = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit	
Reverse Voltage		V <sub>R</sub>	5	V	
Forward Current		I <sub>F</sub>	100	mA	
Peak Forward Current	$t_p/T = 0.5, t_p = 100 \mu s$	I <sub>FM</sub>	200	mA	
Surge Forward Current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	1.5	Α	
Power Dissipation		P <sub>V</sub>	180	mW	
Junction Temperature		T <sub>j</sub>	100	°C	
Operating Temperature Range		T <sub>amb</sub>	- 40 to + 85	°C	
Storage Temperature Range		T <sub>stg</sub>	- 40 to + 100	°C	
Soldering Temperature	$t \le 5$ sec, 2 mm from case	T <sub>sd</sub>	260	°C	
Thermal Resistance Junction/ Ambient		R <sub>thJA</sub>	270	K/W	

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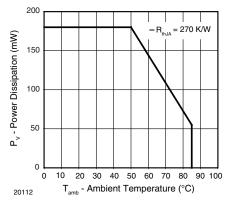


Figure 1. Power Dissipation Limit vs. Ambient Temperature

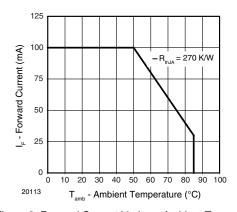


Figure 2. Forward Current Limit vs. Ambient Temperature

## **Basic Characteristics**

 $T_{amb}$  = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Тур.	Max	Unit
Forward Voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V <sub>F</sub>		1.4	1.6	V
	$I_F = 1 \text{ A}, t_p = 100 \mu s$	V <sub>F</sub>		2.3		V
Temp. Coefficient of V <sub>F</sub>	I <sub>F</sub> = 100 mA	TK <sub>VF</sub>		- 2.1		mV/K
Reverse Current	V <sub>R</sub> = 5 V	I <sub>R</sub>			10	μΑ
Junction Capacitance	$V_R = 0 \text{ V, } f = 1 \text{ MHz, } E = 0$	C <sub>j</sub>		125		pF
Radiant Intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	I <sub>e</sub>	68	140	340	mW/sr
	$I_F = 1 \text{ A}, t_p = 100 \ \mu\text{s}$	I <sub>e</sub>		1400		mW/sr
Radiant Power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	φ <sub>e</sub>		48		mW
Temp. Coefficient of $\phi_e$	I <sub>F</sub> = 100 mA	TKφ <sub>e</sub>		- 0.35		%/K
Angle of Half Intensity		φ		± 10		deg
Peak Wavelength	I <sub>F</sub> = 100 mA	$\lambda_{p}$		890		nm
Spectral Bandwidth	I <sub>F</sub> = 100 mA	Δλ		40		nm
Temp. Coefficient of $\lambda_p$	I <sub>F</sub> = 100 mA	$TK\lambda_p$		0.25		nm/K
Rise Time	I <sub>F</sub> = 100 mA	t <sub>r</sub>		30		ns
Fall Time	I <sub>F</sub> = 100 mA	t <sub>f</sub>		30		ns
Cut-Off Frequency	$I_{DC}$ = 70 mA, $I_{AC}$ = 30 mA pp	f <sub>c</sub>		12		MHz
Virtual Source Diameter		Ø		3.7		mm



## **Typical Characteristics**

 $T_{amb}$  = 25 °C unless otherwise specified

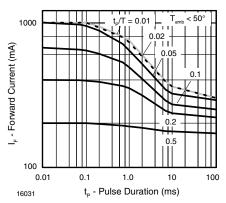
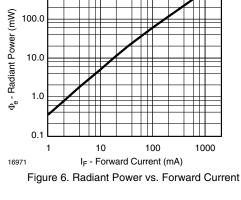


Figure 3. Pulse Forward Current vs. Pulse Duration



1000.0

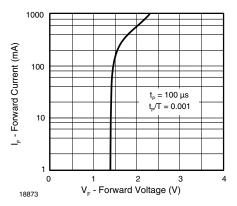


Figure 4. Forward Current vs. Forward Voltage

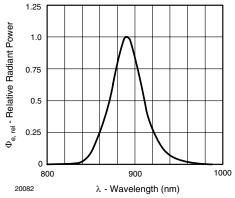


Figure 7. Relative Radiant Power vs. Wavelength

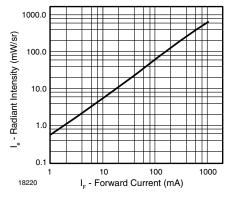


Figure 5. Radiant Intensity vs. Forward Current

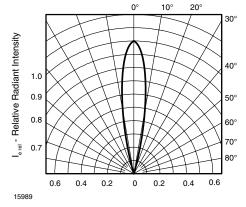
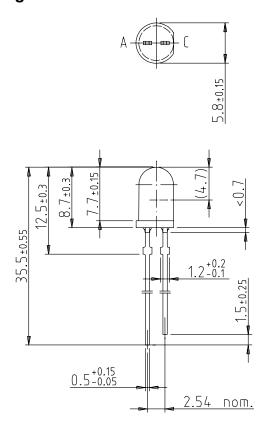
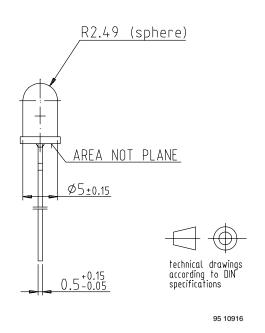


Figure 8. Relative Radiant Intensity vs. Angular Displacement

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# Package Dimensions in mm







## **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

> We reserve the right to make changes to improve technical design and may do so without further notice.

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